



ZXTP2027F

60V PNP MEDIUM POWER TRANSISTOR IN SOT23

Features

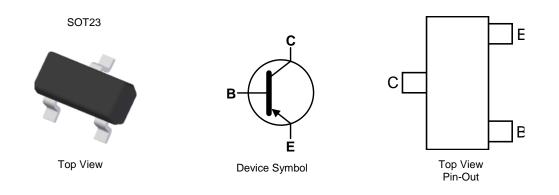
- $BV_{CEO} > -60V$
- I_C = -4A High Continuous Collector Current
- I_{CM} = -10A Peak Pulse Current
- Low Saturation Voltage -60mV Max @ $I_C = -1A$.
- $R_{CE(SAT)} = 45m\Omega$ at 1A for a Low Equivalent On-Resistance
- 1.2W Power Dissipation
- Complimentary NPN Type: ZXTN2018F
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23 •
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight 0.008 grams (Approximate)

Application

- Gate Driving MOSFETs and IGBTs
- Motor Drive
- Relay, Lamp and Solenoid Drive
- **High Side Switches**



Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel	
ZXTP2027FTA 951		7	8	3,000	
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

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2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-100	V
Collector-Emitter Voltage	V _{CEV}	-100	V
Collector-Emitter Voltage	V _{CEO}	-60	V
Emitter-Base Voltage	V _{EBO}	-7	V
Peak Pulse Collector Current	I _{CM}	-10	А
Continuous Collector Current	I _C	-4	А
Base Current	IB	-1	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.0	W
Power Dissipation (Note 6)	PD	1.2	W
Power Dissipation (Note 7)	PD	1.56	W
Thermal Resistance, Junction to Ambient Air (Note 5)	R _{0JA}	125	°C/W
Thermal Resistance, Junction to Ambient Air (Note 6)	R _{0JA}	104	°C/W
Thermal Resistance, Junction to Ambient Air (Note 7)	R _{θJA}	80	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

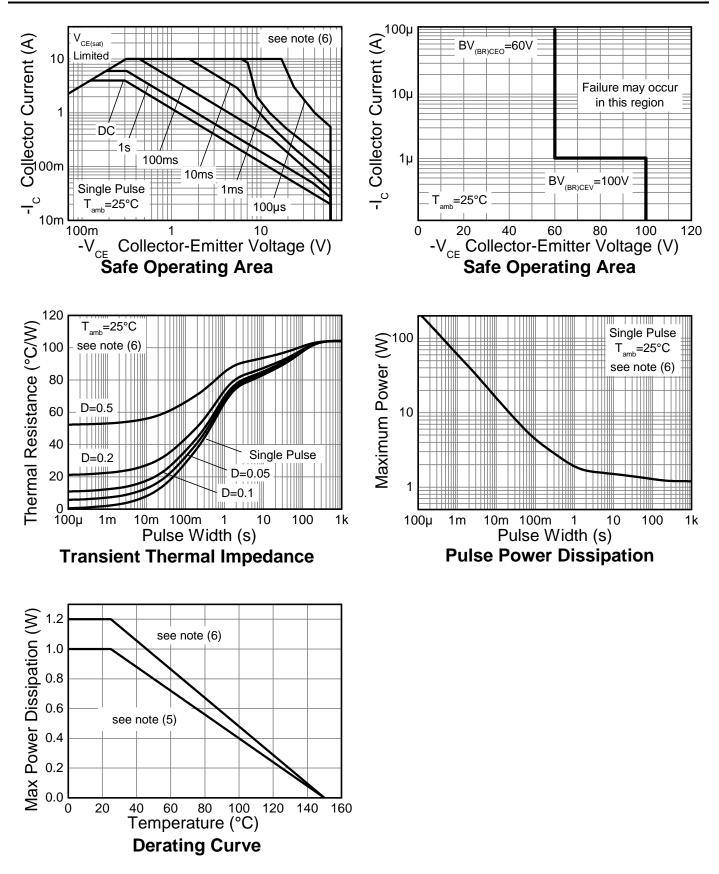
ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted with the collector lead on 18mm x 18mm 2oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.
Same as note (5), except the device is mounted on 30mm x 30mm 2oz copper.
Same as note (6), except measured at t<5secs.
Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





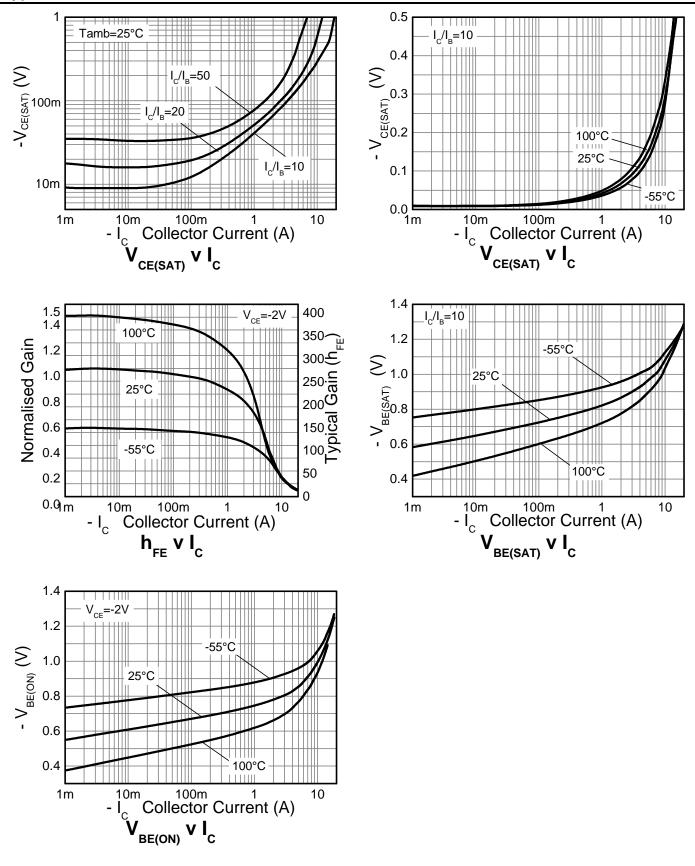
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage		-100	-120	_	V	I _C = -100μA
Collector-Emitter Breakdown Voltage	BV _{CEV}	-100	-120	_	V	$I_{C} = -1\mu A$, $1V > V_{BE} > -0.3V$
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	-60	-75		V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7.0	-8.2	_	V	I _E = -100μA
Collector-Emitter Cutoff Current	I _{CEV}			-20	nA	$V_{CE} = -80V, V_{BE} = 1V$
Collector-Base Cutoff Current	I _{CBO}			-20	nA	$V_{CB} = -80V, I_E = 0$
Emitter-Base Cutoff Current	I _{EBO}			-10	nA	$V_{EB} = -6V, I_{C} = 0$
ON CHARACTERISTICS (Note 9)						
		100	250			$V_{CE} = -2V, I_{C} = -10mA$
DC Current Gain	h	100	200	300		$V_{CE} = -2V, I_{C} = -2A$
	h _{FE}	80	145	_		$V_{CE} = -2V, I_{C} = -4A$
		20	40	—		$V_{CE} = -2V, I_{C} = -10A$
			-15	-25		$I_{C} = -100 \text{mA}, I_{B} = -10 \text{mA}$
Collector-Emitter Saturation Voltage	Manua (-45	-60	mV	$I_{C} = -1A, I_{B} = -100mA$
	V _{CE(SAT)}		-70	-95		$I_{C} = -2A, I_{B} = -200mA$
			-155	-240		I _C = -4A, I _B = -200mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	_	-0.89	-1.0	V	I _C = -4A, I _B = -200mA
Base-Emitter Turn-On Voltage	V _{BE(ON)}		-0.81	-0.95	V	$V_{CE} = -2V, I_{C} = -4A$
SMALL SIGNAL CHARACTERISTICS						
	t _D		12.6			
Switching times	t _R		10.2	—	ns	$V_{CC} = -10V,$ $I_{C} = -2A,$ $-I_{B1} = I_{B2} = -200mA$
Switching times	ts		220	_		
	t _F		21	_		5. 52
Transition Frequency	f _T		165	_	MHz	$V_{CE} = -10V, I_C = -100mA, f = 50MHz$
Output Capacitance	C _{OBO}		44		pF	V _{CB} = -10V, f = 1MHz

Note: 9. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



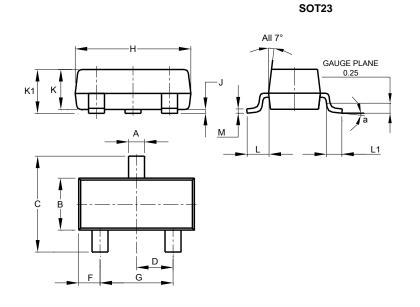
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)





Package Outline Dimensions

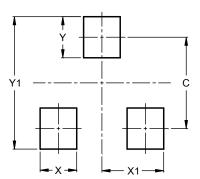
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
ĸ	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



 Dimensions
 Value (in mm)

 C
 2.0

 X
 0.8

 X1
 1.35

 Y
 0.9

 Y1
 2.9

SOT23



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